



Patent Application

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Gerald Frieese

Examiner: Song, Matthew J.

Serial No: 09/893,160

Group: Art Unit 1765

Filed: June 27, 2001

Docket: 8055-83CIP (In1292USD1)

For: **POWER PADS FOR APPLICATION OF HIGH CURRENT
PER BOND PAD IN SILICON TECHNOLOGY**

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA. 22313

RECEIVED
AUG 30 2004
TC 1700


AMENDMENT

This is a response to the Office Action mailed on March 24, 2004. Please amend the above-identified application as follows:

CERTIFICATE OF MAILING 37 C.F.R. § 1.8(a)

I hereby certify that this correspondence (and any document referred to as being attached or enclosed) is being deposited with the United States Postal Service as first class mail, postage paid in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on August 24, 2004.

Dated: August 24, 2004


Frank V. DeRosa